

HIGH TOUGHNESS

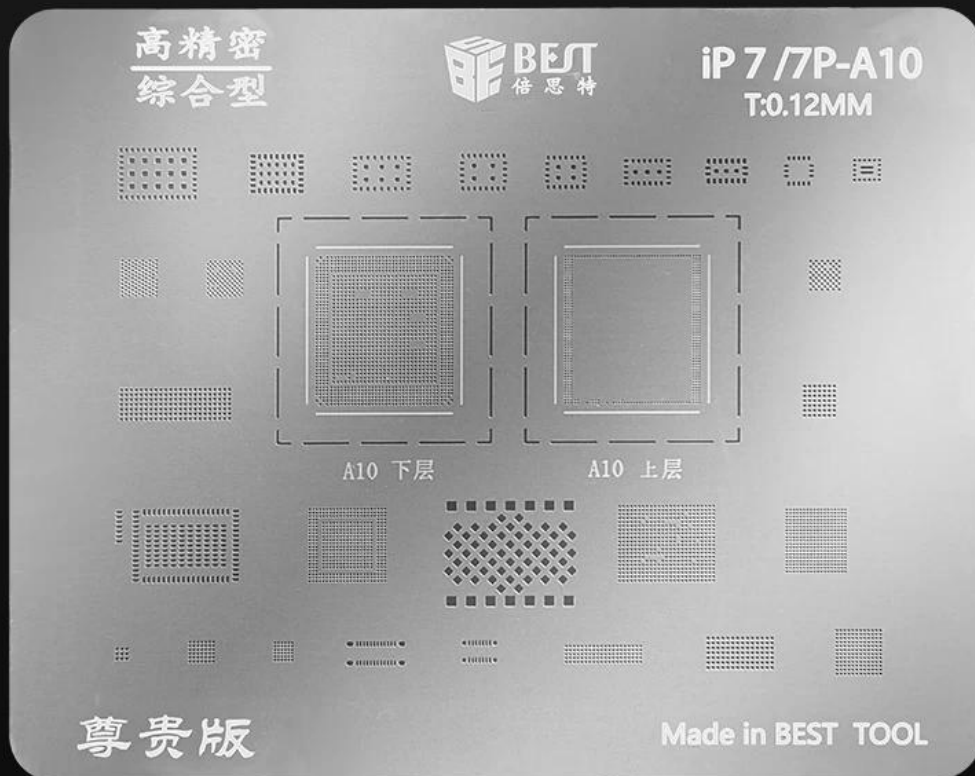
BGA IC

Soldering Reballing Stencil



iP 7/7P-A10

Strong magnetic steel



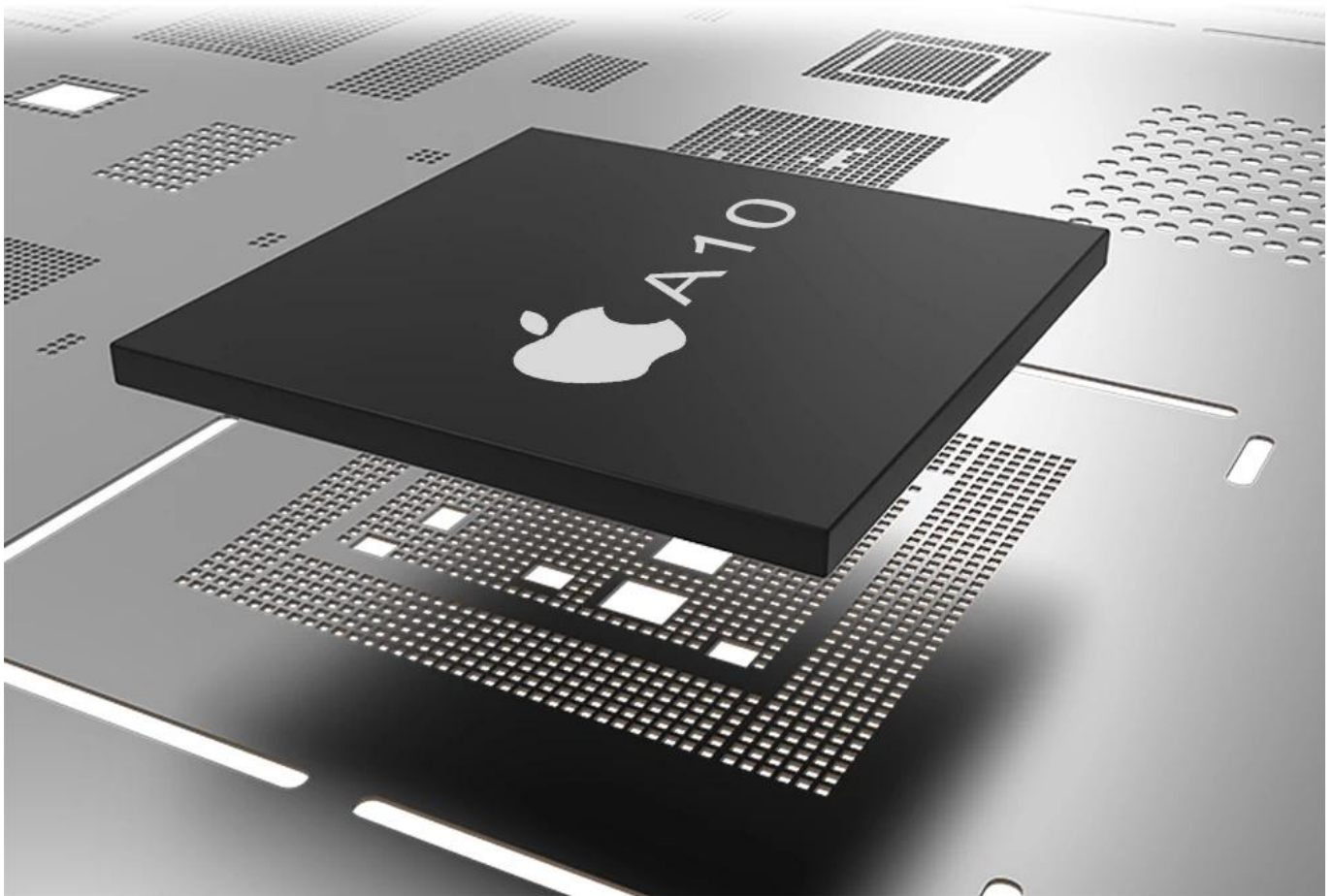
Product Usage

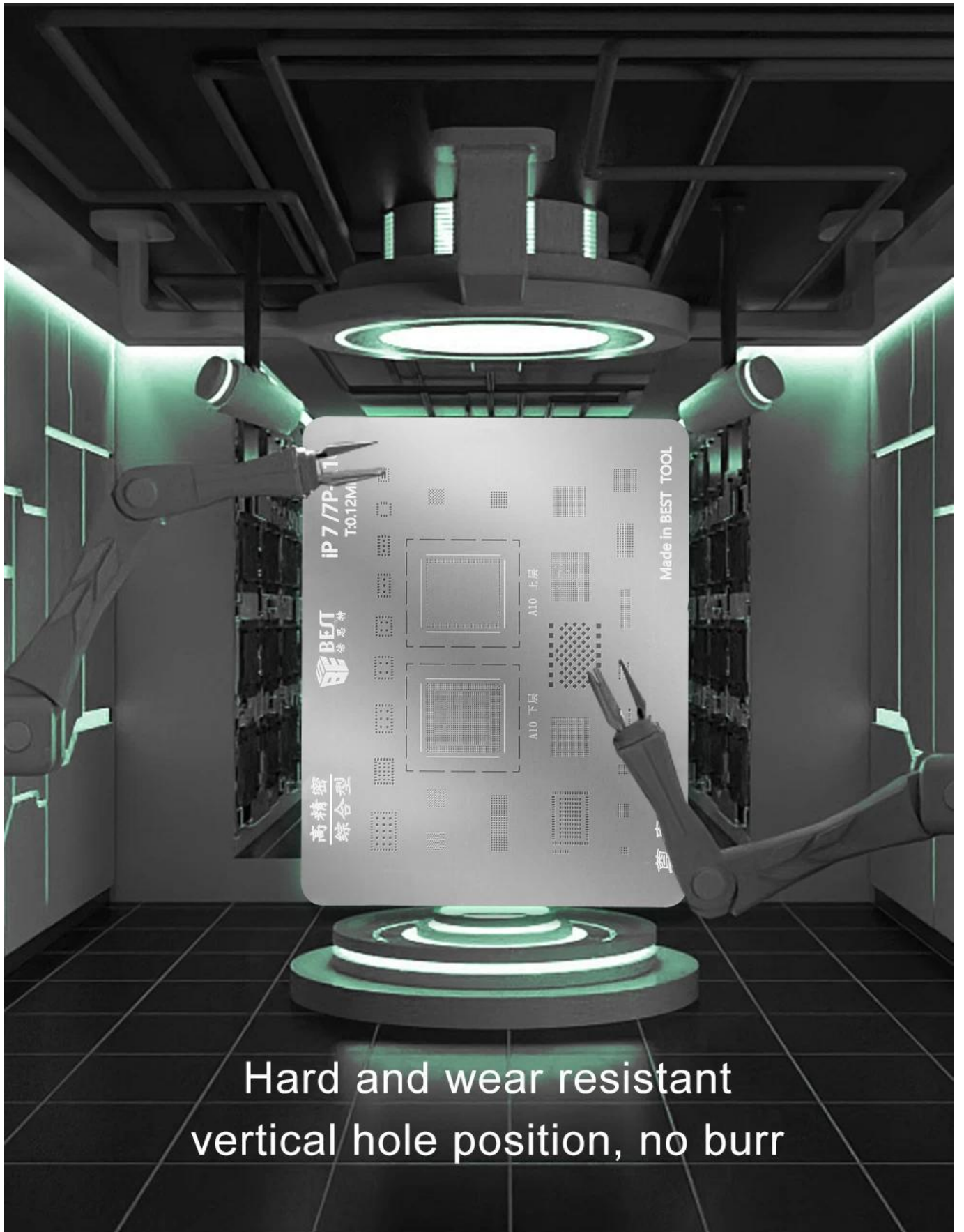
Model NO.	iP 7/7P-A10
Name	Reballing Stencil
Material	Strong magnetic steel
Melting point	700°C
G.W.	12.9g
Size	3.36*4.30 in.





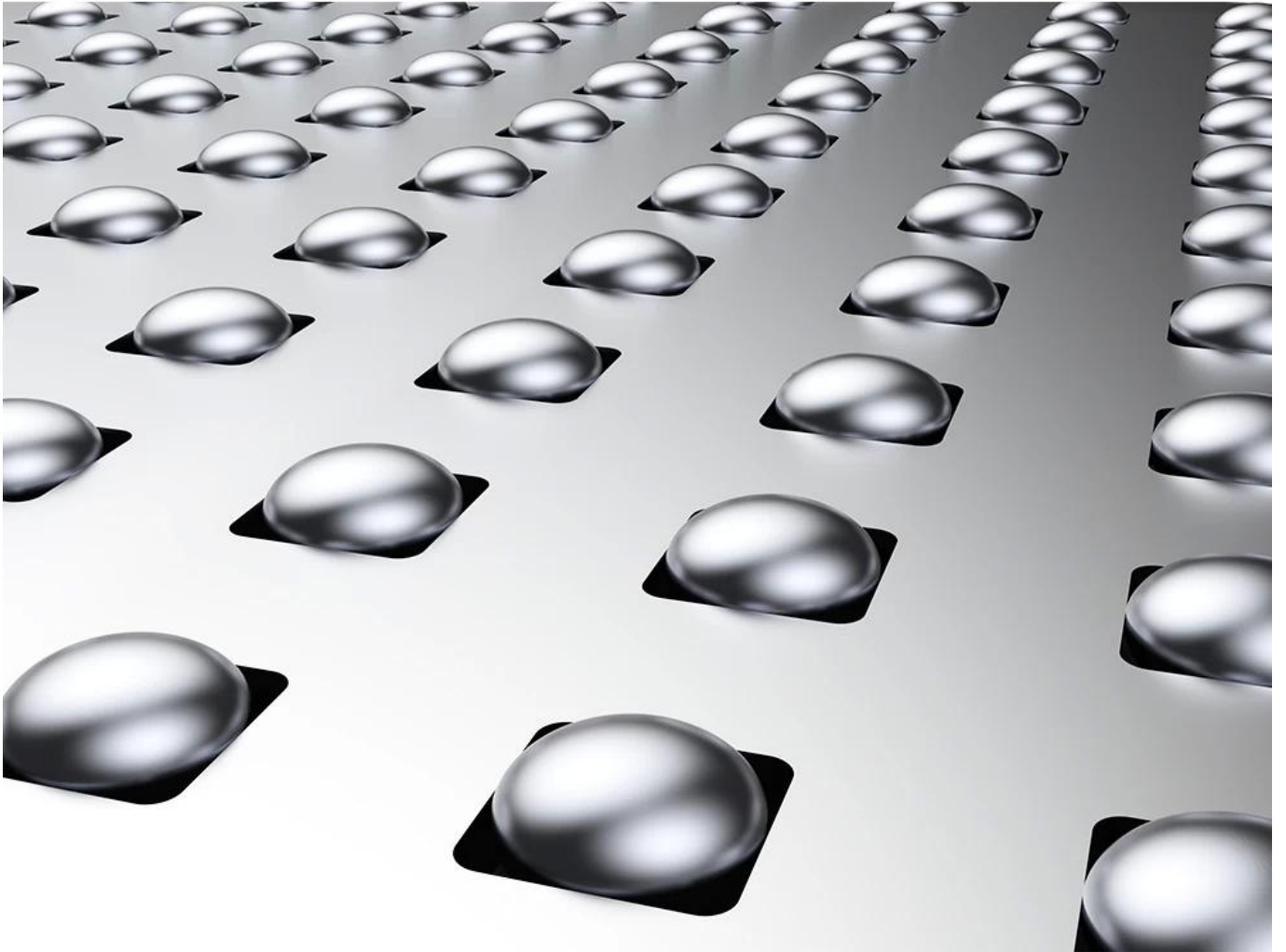
Easily mounted on the steel mesh to make the chip fit more closely with the mesh Therefore.





Hard and wear resistant
vertical hole position, no burr

Precision Reballing Stencil
Tin point is neat and tidy



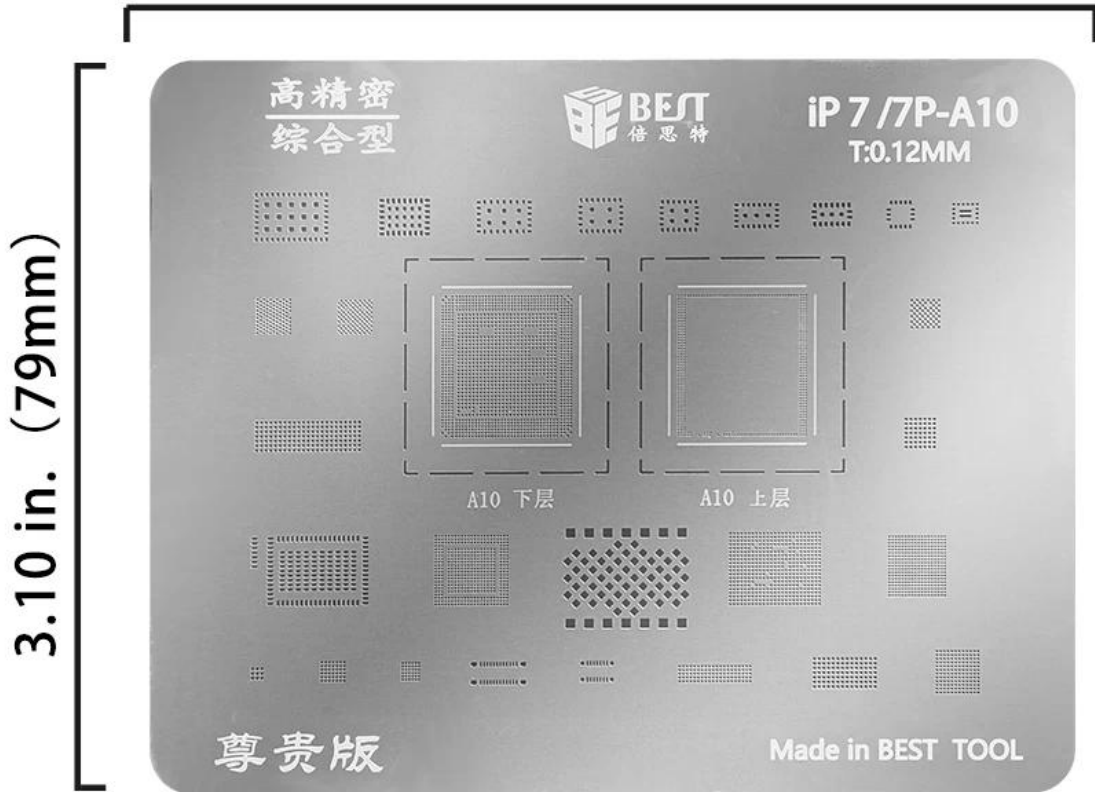


Product List



N.W.:6.9g

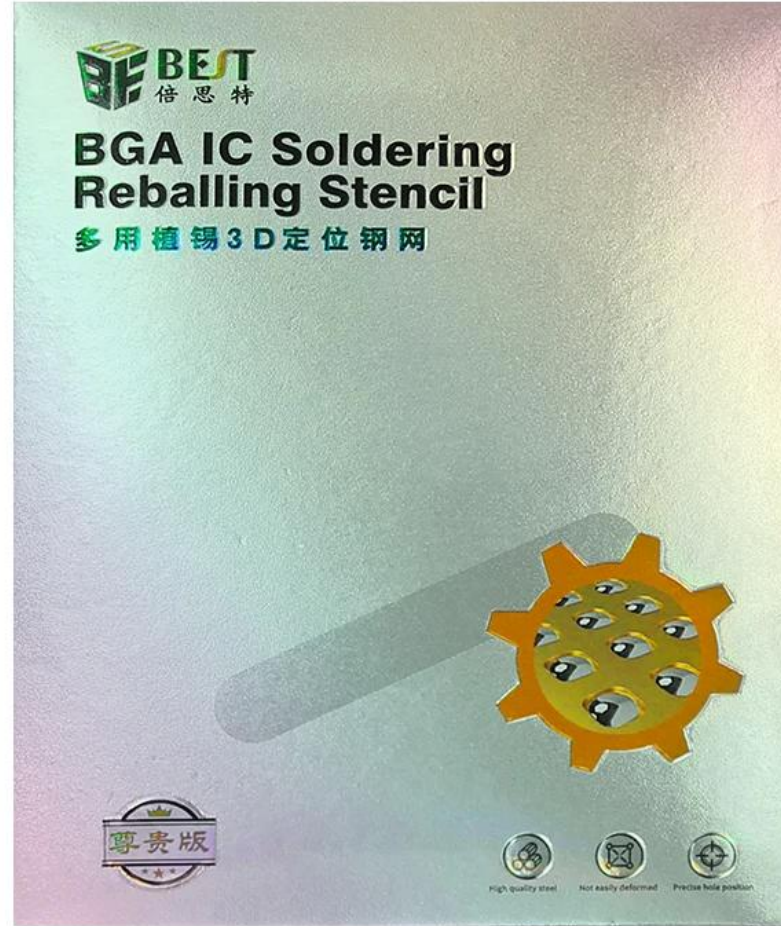
3.89 in. (98mm)



G.W.:12.9g

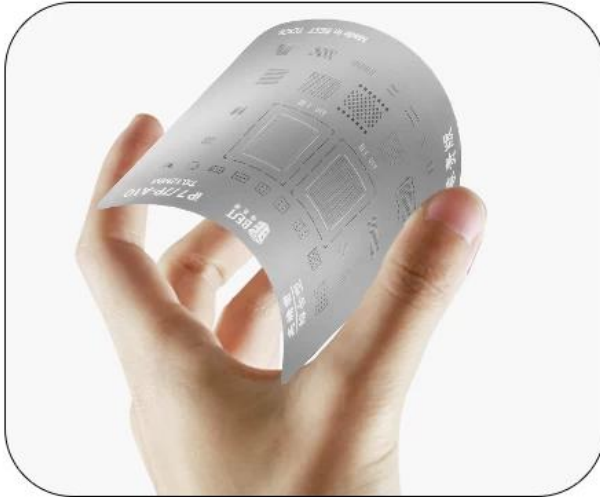
3.36 in. (85mm)

4.30 in. (109mm)



Thin to 0.12mm

Precise die-casting **form heating**



Not easily deformed and scratched

